

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	20	V
RMS Reverse Voltage	V _{R(RMS)}	14	V
Average Rectified Output Current (See Figure 3)	I _O	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	5	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5)	R _{ΘJA}	378	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	20	—	—	V	I _R = 100μA
Forward Voltage Drop	V _F	—	0.39 0.47	0.45 0.52	V	I _F = 0.2A, T _J = 25°C I _F = 0.5A, T _J = 25°C
Leakage Current (Note 6)	I _R	—	6 1.5	100 20	μA mA	V _R = 20V, T _J = 25°C V _R = 20V, T _J = 150°C

Notes: 5. Device mounted on FR-4 1*MRP substrate PCB with recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
6. Short duration pulse test used to minimize self-heating effect.

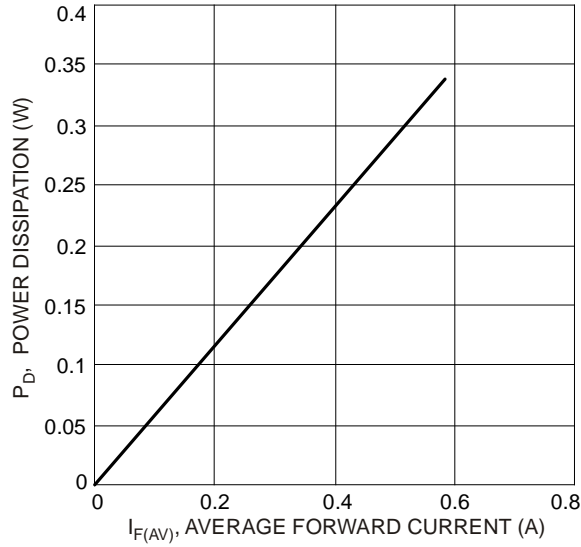


Fig. 1 Forward Power Dissipation

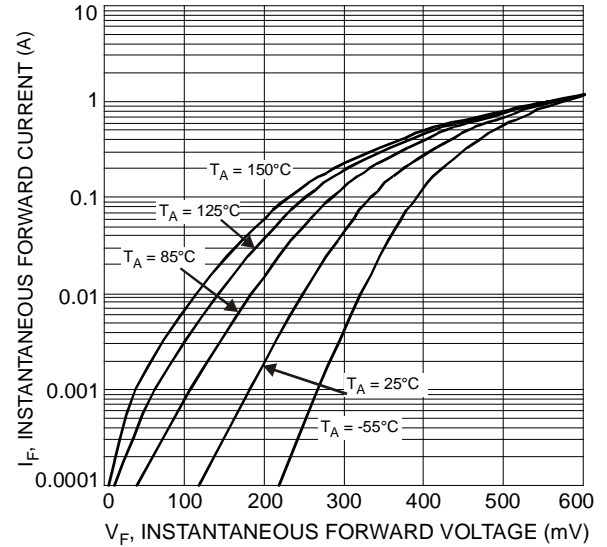


Fig. 2 Typical Forward Characteristics

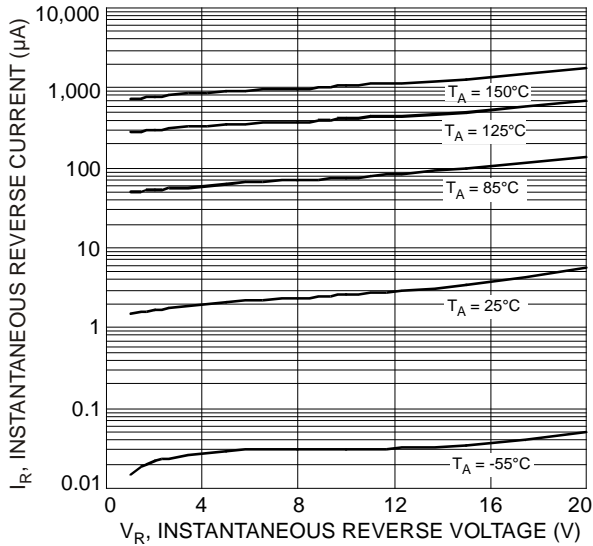


Fig. 3 Typical Reverse Characteristics

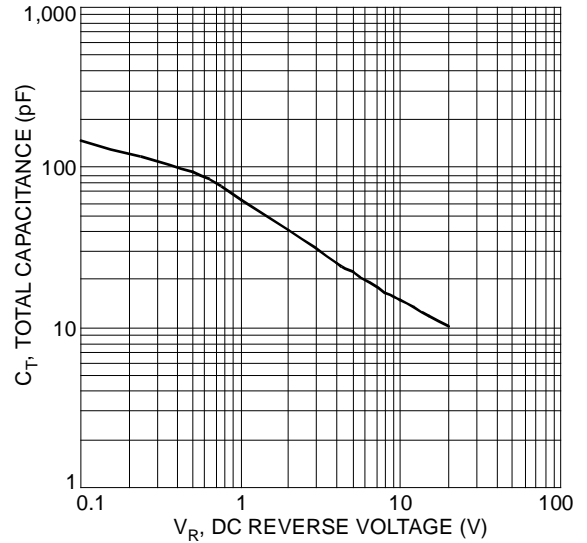


Fig. 4 Total Capacitance vs. Reverse Voltage

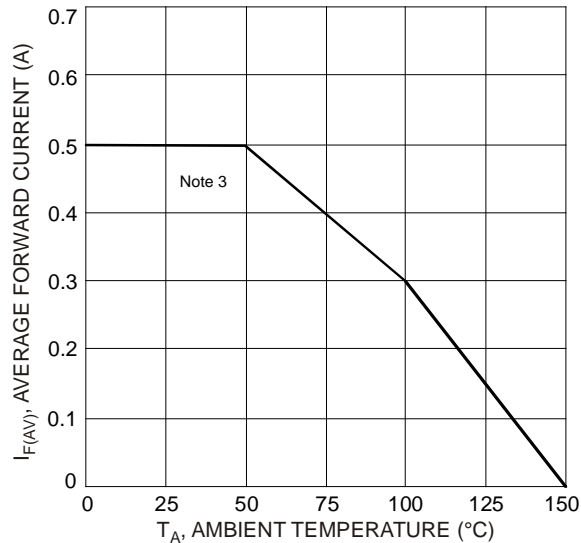


Fig. 5 Forward Current Derating Curve

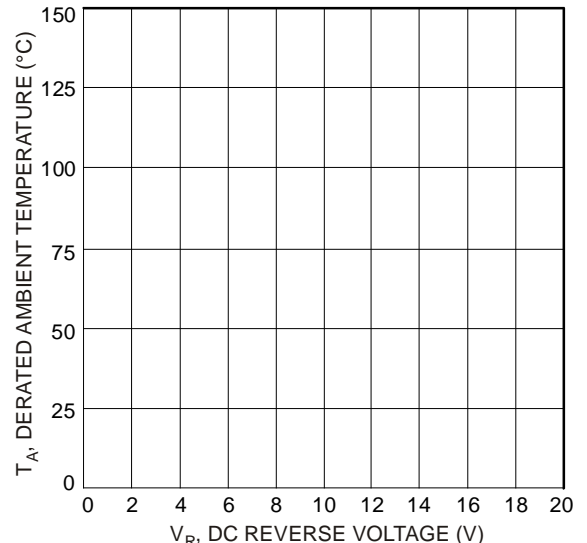


Fig. 6 Operating Temperature Derating

Marking Information

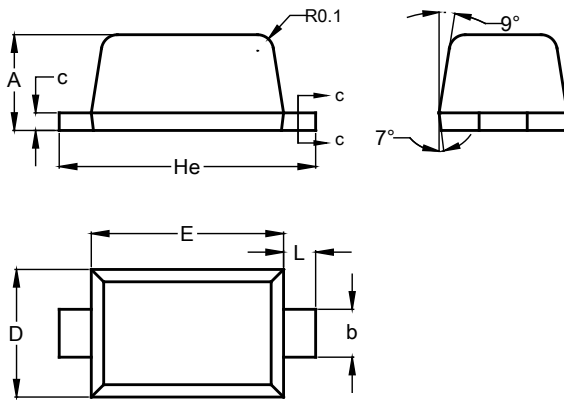
52

52 = Product Type Marking Code
Dot Denotes Cathode Side

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD523

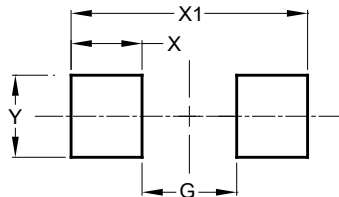


SOD523		
Dim	Min	Max
A	0.55	0.65
b	0.26	0.34
c	0.11	0.17
D	0.75	0.85
E	1.15	1.25
He	1.55	1.65
L	0.10	0.30
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD523



Dimensions	Value (in mm)
G	0.80
X	0.60
X1	2.00
Y	0.70

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